

TOSHIBA Field Effect Transistor Silicon N Channel Junction Type

2SK3376TK

For ECM

- Application for Ultra-compact ECM

Absolute Maximum Ratings (Ta=25°C)

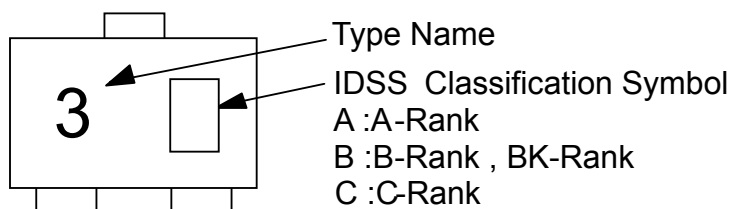
Characteristic	Symbol	Rating	Unit
Gate-Drain voltage	V _{GDO}	-20	V
Gate Current	I _G	10	mA
Drain power dissipation (Ta = 25°C)	P _D	100	mW
Junction Temperature	T _j	125	°C
Storage temperature range	T _{stg}	-55~125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

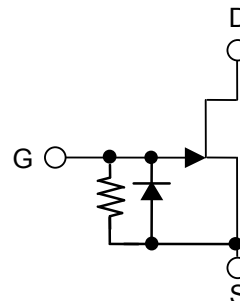
IDSS CLASSIFICATION

A-Rank	80 to 200μA
B-Rank	170 to 300μA
C-Rank	270 to 480μA
BK-Rank	150 to 350μA

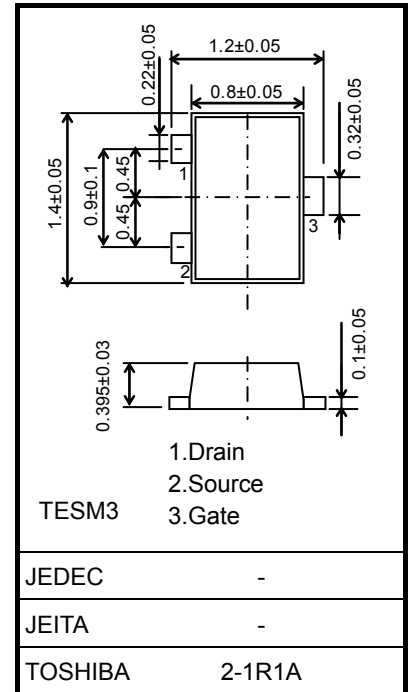
Marking



Equivalent Circuit



Unit: mm



Weight: 2.2mg (typ.)

Electrical Characteristics (A-Rank IDSS Ta=25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Drain Current	I _{DSS}	V _{DS} = 2 V, V _{GS} = 0	80	—	200	μA
Drain Current	I _D	V _{DD} = 2 V, RL = 2kΩ, Cg = 3pF	—	—	240	μA
Gate-Source Cut-off Voltage	V _{GS(OFF)}	V _{DS} = 2 V, I _D = 1μA	-0.1	—	-0.8	V
Forward transfer admittance	Y _{fs}	V _{DS} = 2 V, V _{GS} = 0V	0.7	1.4	—	mS
Input capacitance	C _{iss}	V _{DS} = 2 V, V _{GS} = 0, f = 1 MHz	—	5.5	—	pF
Voltage Gain	G _v	V _{DD} = 2V, RL = 2kΩ, Cg = 3pF, f = 1kHz	-13.5	—	-9.0	dB
Delta Voltage Gain	DG _{v(f)}	V _{DD} = 2V, RL = 2kΩ, Cg = 3pF, f = 1kHz to 100Hz	—	—	-2.0	dB
Delta Voltage Gain	DG _{v(V)}	V _{DD} = 2V to 1V, RL = 2kΩ, Cg = 3pF, f = 1kHz	—	—	-4.0	dB
Noise Voltage	V _N	V _{DD} = 2V, RL = 1kΩ, Cg = 3pF, G _v = 80dB, f = A-Curve Filter	—	—	47	mV

Electrical Characteristics (B-Rank IDSS Ta=25°C)

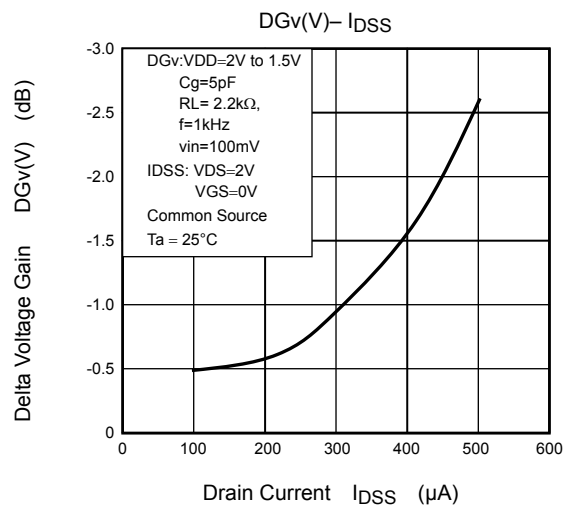
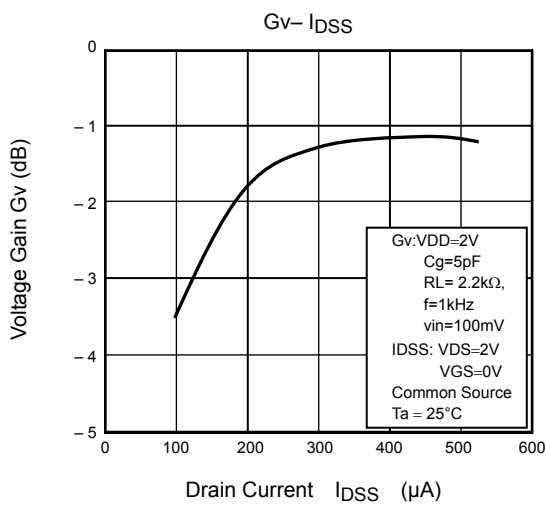
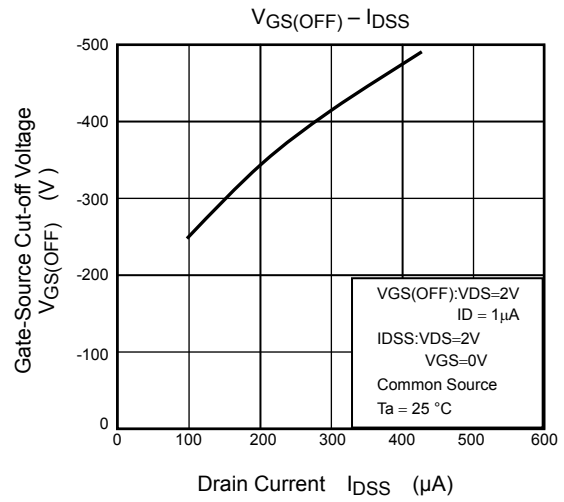
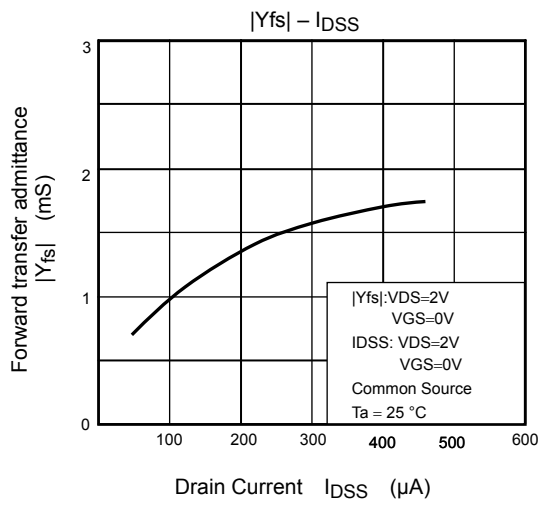
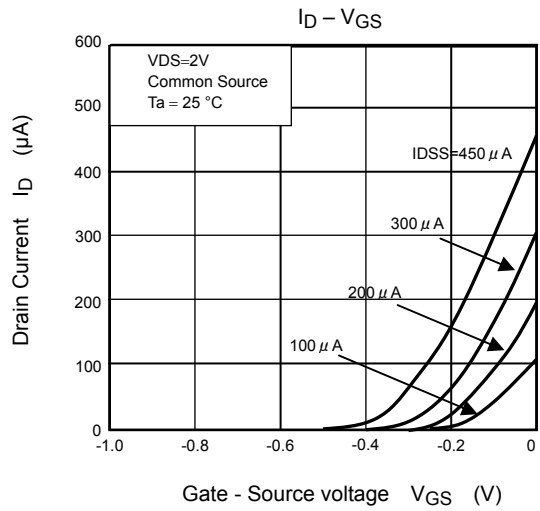
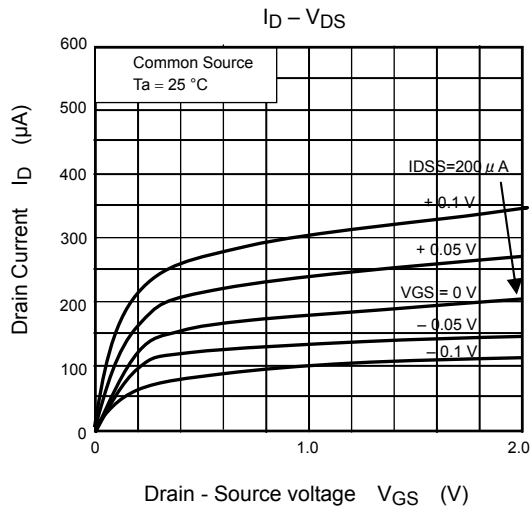
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Drain Current	I _{DSS}	V _{DS} = 2 V, V _{GS} = 0	170	—	300	μA
Drain Current	I _D	V _{DD} = 2 V, RL = 2kΩ, Cg = 3pF	—	—	340	μA
Gate-Source Cut-off Voltage	V _{GS(OFF)}	V _{DS} = 2 V, I _D = 1μA	-0.15	—	-1.0	V
Forward transfer admittance	Y _{fs}	V _{DS} = 2 V, V _{GS} = 0V	0.7	1.4	—	mS
Input capacitance	C _{iss}	V _{DS} = 2 V, V _{GS} = 0, f = 1 MHz	—	5.5	—	pF
Voltage Gain	G _v	V _{DD} = 2V, RL = 2kΩ, Cg = 3pF, f = 1kHz	-11.5	—	-8.0	dB
Delta Voltage Gain	DG _{v(f)}	V _{DD} = 2V, RL = 2kΩ, Cg = 3pF, f = 1kHz to 100Hz	—	—	-2.0	dB
Delta Voltage Gain	DG _{v(V)}	V _{DD} = 2V to 1V, RL = 2kΩ, Cg = 3pF, f = 1kHz	—	—	-7.0	dB
Noise Voltage	V _N	V _{DD} = 2V, RL = 1kΩ, Cg = 3pF, G _v = 80dB, f = A-Curve Filter	—	—	50	mV

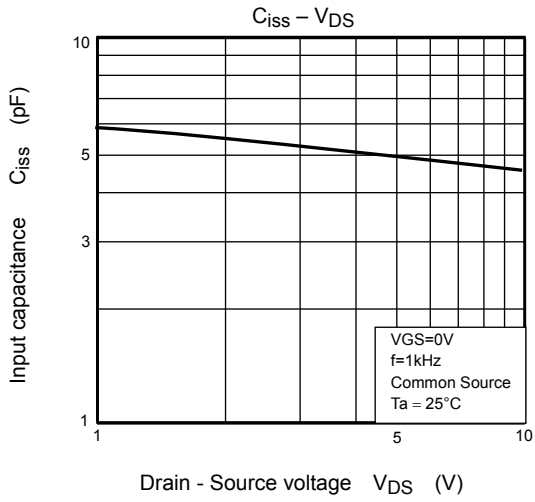
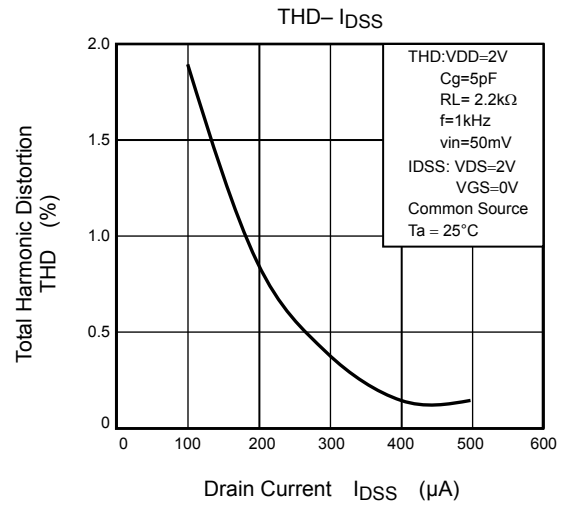
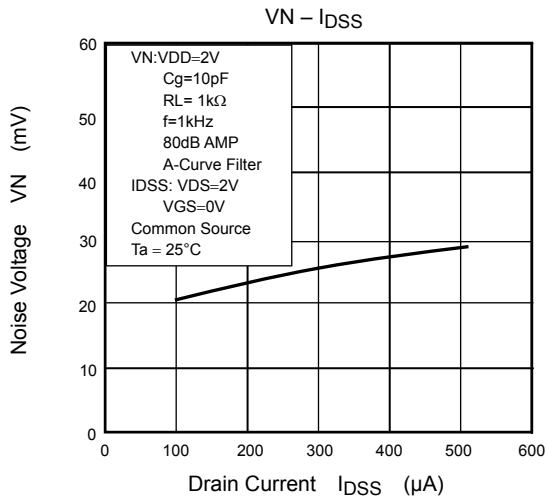
Electrical Characteristics (C-Rank IDSS Ta=25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Drain Current	I _{DSS}	V _{DS} = 2 V, V _{GS} = 0	270	—	480	μA
Drain Current	I _D	V _{DD} = 2 V, RL = 2kΩ, Cg = 3pF	—	—	520	μA
Gate-Source Cut-off Voltage	V _{GS(OFF)}	V _{DS} = 2 V, I _D = 1μA	-0.2	—	-1.2	V
Forward transfer admittance	Y _{fs}	V _{DS} = 2 V, V _{GS} = 0V	0.7	1.4	—	mS
Input capacitance	C _{iss}	V _{DS} = 2 V, V _{GS} = 0, f = 1 MHz	—	5.5	—	pF
Voltage Gain	G _v	V _{DD} = 2V, RL = 2kΩ, Cg = 3pF, f = 1kHz	-10.5	—	-6.75	dB
Delta Voltage Gain	DG _{v(f)}	V _{DD} = 2V, RL = 2kΩ, Cg = 3pF, f = 1kHz to 100Hz	—	—	-2.0	dB
Delta Voltage Gain	DG _{v(V)}	V _{DD} = 2V to 1V, RL = 2kΩ, Cg = 3pF, f = 1kHz	—	—	-20	dB
Noise Voltage	V _N	V _{DD} = 2V, RL = 1kΩ, Cg = 3pF, G _v = 80dB, f = A-Curve Filter	—	—	75	mV

Electrical Characteristics (BK-Rank IDSS Ta=25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Drain Current	I_{DSS}	$V_{DS} = 2\text{ V}, V_{GS} = 0$	150	—	350	μA
Drain Current	I_D	$V_{DD} = 2\text{ V}, R_L = 2\text{ k}\Omega, C_g = 3\text{ pF}$	—	—	390	μA
Gate-Source Cut-off Voltage	$V_{GS(OFF)}$	$V_{DS} = 2\text{ V}, I_D = 1\mu\text{A}$	-0.125	—	-1.1	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 2\text{ V}, V_{GS} = 0\text{ V}$	0.7	1.4	—	mS
Input capacitance	C_{iss}	$V_{DS} = 2\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	5.5	—	pF
Voltage Gain	G_v	$V_{DD} = 2\text{ V}, R_L = 2\text{ k}\Omega, C_g = 3\text{ pF}, f = 1\text{ kHz}$	-12.0	—	-7.50	dB
Delta Voltage Gain	$DG_v(f)$	$V_{DD} = 2\text{ V}, R_L = 2\text{ k}\Omega, C_g = 3\text{ pF}, f = 1\text{ kHz to } 100\text{ Hz}$	—	—	-2.0	dB
Delta Voltage Gain	$DG_v(V)$	$V_{DD} = 2\text{ V to } 1\text{ V}, R_L = 2\text{ k}\Omega, C_g = 3\text{ pF}, f = 1\text{ kHz}$	—	—	-13.5	dB
Noise Voltage	V_N	$V_{DD} = 2\text{ V}, R_L = 1\text{ k}\Omega, C_g = 3\text{ pF}, G_v = 80\text{ dB}, f = \text{A-Curve Filter}$	—	—	65	mV





RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patents or other rights of TOSHIBA or the third parties.
- Please contact your sales representative for product-by-product details in this document regarding RoHS compatibility. Please use these products in this document in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses occurring as a result of noncompliance with applicable laws and regulations.